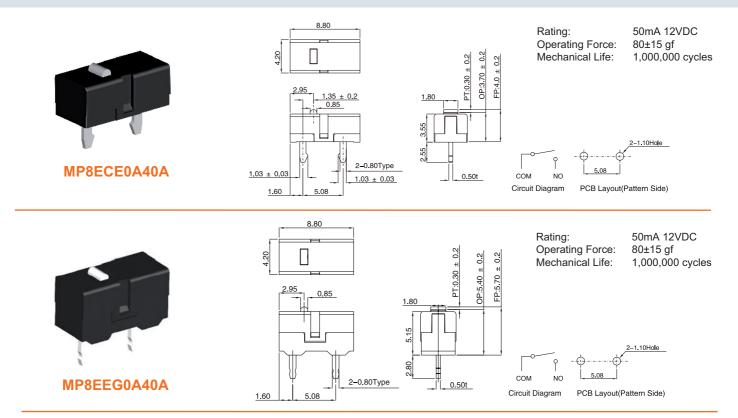
# **Micro Switches**

## Ultraminiature Micro Switches

## **MP8** Series



#### **GENERAL SPECIFICATIONS:**

- > Rating:
- > Contact Resistance:
- > Insulation Resistance:
- > Dielectric Strength:
- > Operating Force:
- > Operating Life:
- > Operating Temperature Range:
- > Ambient Humidity:

#### **MATERIALS:**

- > Base, Cover & Keystroke:
- > Terminals:
- > Contact:
- > Reed:

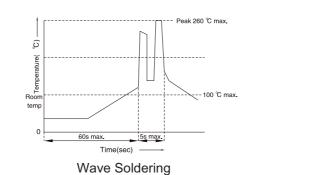
#### SOLDERING CONDITIONS:

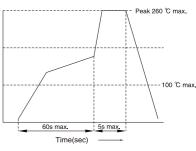
- > Hand Soldering:
- Use a soldering iron of 30W, controlled at 350°C approximately 3 seconds while solder applying.
- > Wave Soldering:
- The peak temperature of the wave oven should be set to 260°C Max. 5 sec. Max.

0.1A 30VDC or 50mA 12VDC (See detail specs)

Base

> Reflow Soldering: The peak temperature of the wave oven should be set to 260°C Max. 5 sec. Max.





**Reflow Soldering** 

-25°C to +80°C 85%RH Max. Contact Nylon Brass silver plating Shrapne Silver alloy

500VAC for 1 minute

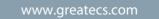
See detail specs

See detail specs

Beryllium bronze

REATEC

100 mQ Max. 100 MΩ at 500VDC



Keystoke

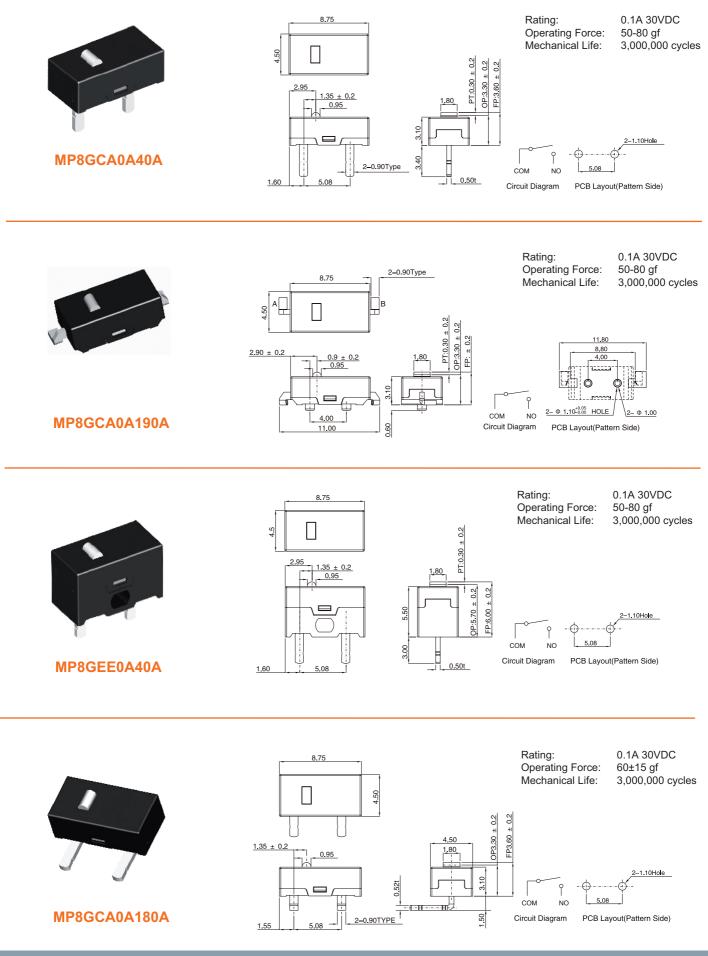
Cover

Terminal

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sales@greatecs.com

